

■ PRODUCT CHARACTERISTICS

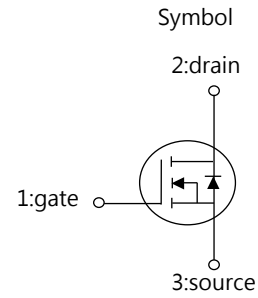
$V_{DS}$	200V
$R_{DS(on)Typ}(@V_{GS}=10V)$	110m $\Omega$
$I_D$	18A

■ APPLICATIONS

Power factor correction  
Switched mode power supplies  
Uninterruptible power supply

■ FEATURES

Ultra low  $R_{DS(on)}$   
100% uis tested  
RoHS compliant



TO-220



TO-220F

■ ORDER INFORMATION

Order codes		Package	Packing
Halogen-free	Halogen		
N/A	MOT18N20F	TO-220F	50pieces/Tube
N/A	MOT18N20A	TO-220	50pieces/Tube

■ ABSOLUTE MAXIMUM RATINGS( $T_c=25^{\circ}C$ , unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-source voltage	$V_{DSS}$	200	V
Continuous drain current	$I_D$	18	A
Continuous drain current ( $T_c=100^{\circ}C$ )		11	A
Pulsed drain current	$I_{DM}$	72	A
Gate source voltage	$V_{GS}$	$\pm 30$	V
Single pulse avalanche energy	$E_{AS}$	580	mJ
Peak diode recovery $dv/dt$	$dv/dt$	5	V/ns
Power dissipation	TO-220	130	W
	Derating factor above $25^{\circ}C$	1.2	$^{\circ}C/W$
	TO-220F	42	W
	Derating factor above $25^{\circ}C$	0.33	$^{\circ}C/W$
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to 150	$^{\circ}C$

## ■ ELECTRICAL CHARACTERISTICS(Tc=25 °C,unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA	200	-	-	V
Drain-source leakage current	I <sub>DSS</sub>	V <sub>DS</sub> =200V, V <sub>GS</sub> =0V	-	-	1	μA
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V	-	-	±100	nA
On characteristics						
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2	-	4	V
On-state characteristics	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =7.5A	-	0.12	0.18	Ω
Forward transconductance	g <sub>fs</sub>	V <sub>GS</sub> =30V, I <sub>D</sub> =9A	5	-	-	S
Dynamic characteristics						
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>DD</sub> =25V f=1MHz	-	1320	-	pF
Out capacitance	C <sub>oss</sub>		-	450	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	130	-	pF
Gate resistance	R <sub>g</sub>	f=1MHz	-	2	-	Ω
Switching characteristics						
Turn-on delay time	t <sub>d(on)</sub>	V <sub>GS</sub> =10V, V <sub>DD</sub> =100V I <sub>D</sub> =18A, R <sub>G</sub> =20Ω	-	15	-	nS
Turn-on rise time	t <sub>r</sub>		-	52	-	nS
Turn-off delay time	t <sub>d(off)</sub>		-	46	-	nS
Turn-off fall time	t <sub>f</sub>		-	37	-	nS
Total gate charge	Q <sub>g</sub>	V <sub>GS</sub> =10V, V <sub>DD</sub> =160V I <sub>D</sub> =18A	-	23	-	nC
Gate-source charge	Q <sub>gs</sub>		-	8	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	6	-	nC
Source-drain diode ratings and characteristics						
Continuous source current	I <sub>S</sub>		-	-	18	A
Maximum pulsed current	I <sub>SM</sub>		-	-	72	A
Diode forward voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =18A	-	-	1.2	V
Reverse recovery time	T <sub>rr</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =18A dI <sub>F</sub> /dt=100A/us	-	350	-	nS
Reverse recovery charge	Q <sub>rr</sub>		-	3600	-	nC

■ TYPICAL CHARACTERISTICS

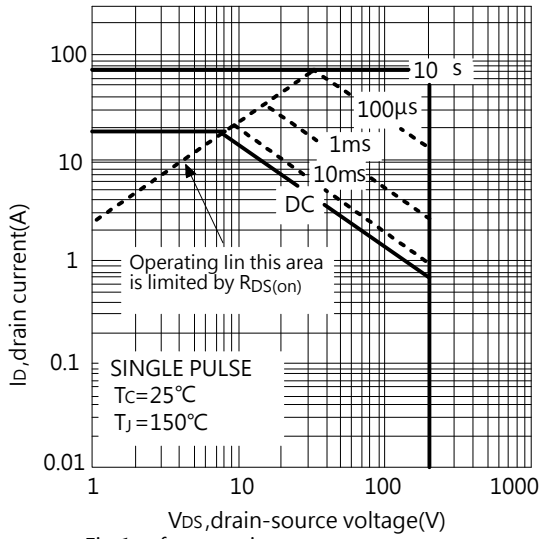


Fig 1 safe operating area

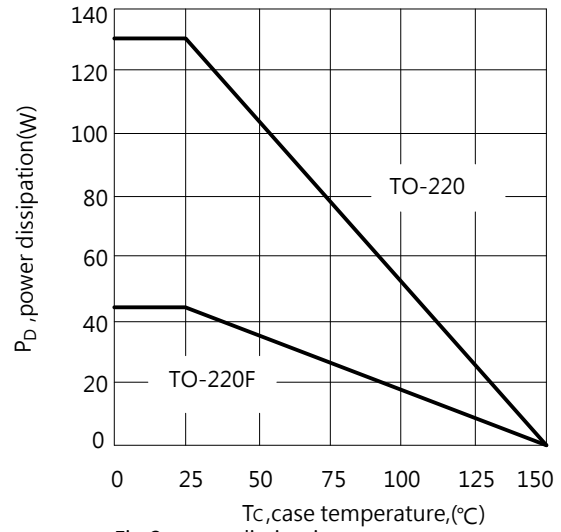


Fig 2 power dissipation

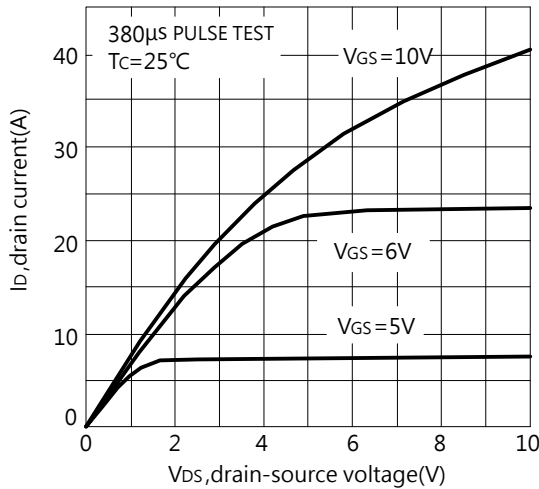


Fig 3 typical output characteristics

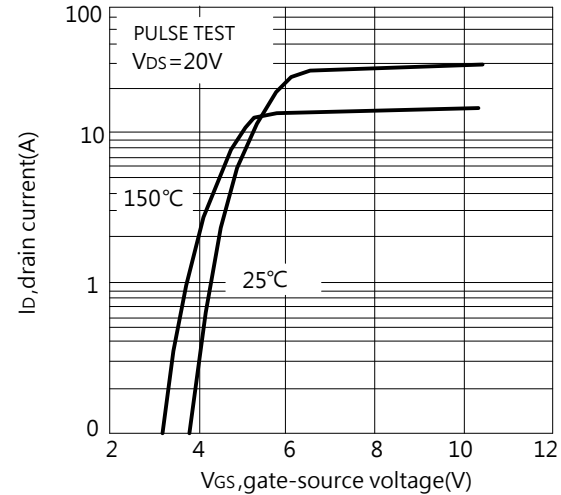


Fig 4 typical transfer characteristics

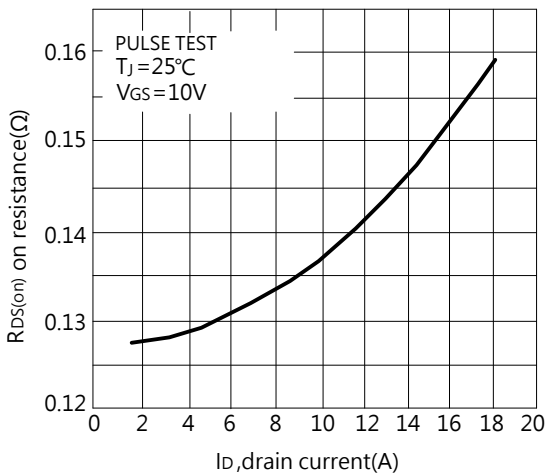


Fig 5 typical drain to source on resistance vs drain current

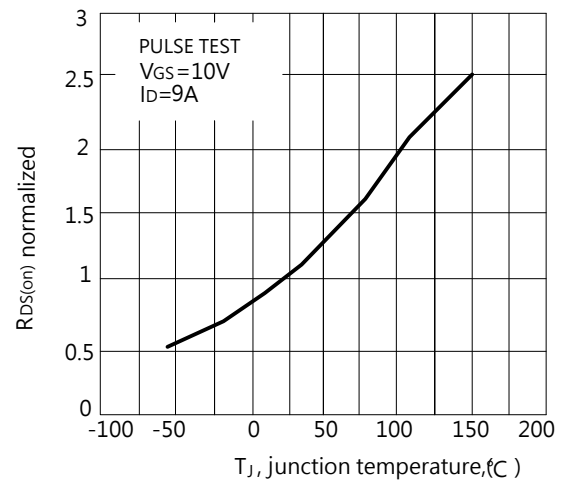


Fig 6 typical breakdown voltage vs junction temperature

■ TYPICAL CHARACTERISTICS(Cont.)

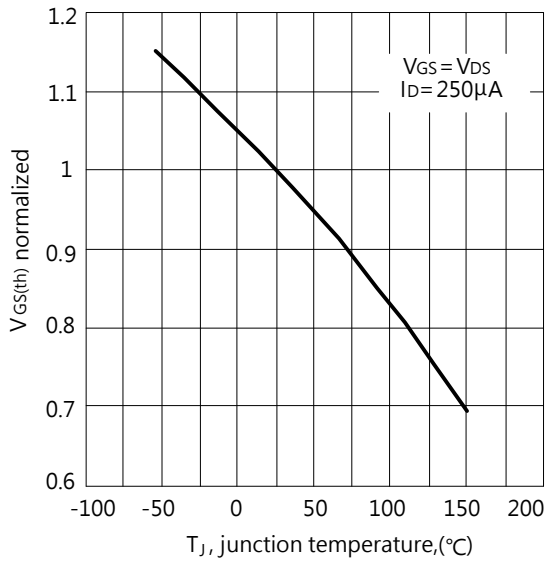


Fig 7 typical threshold voltage vs junction temperature

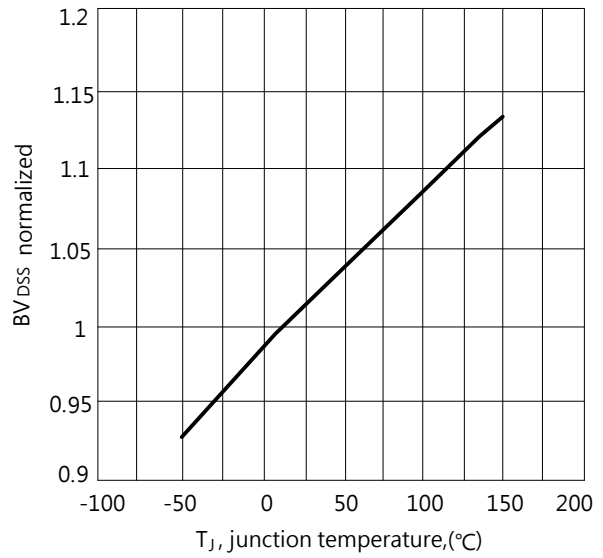


Fig 8 typical breakdown voltage vs junction temperature

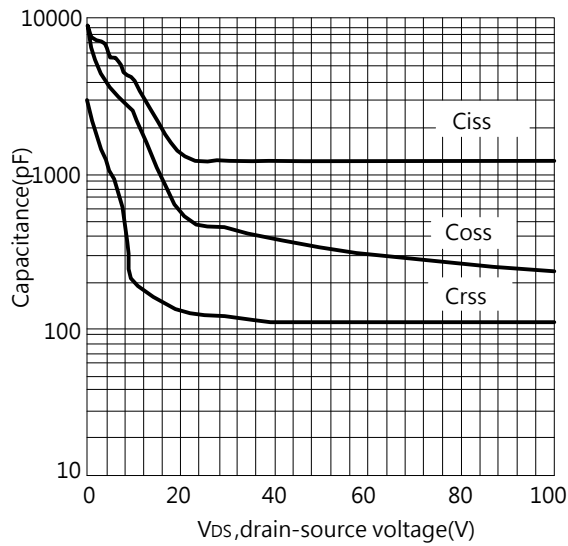


Fig 9 capacitance characteristics

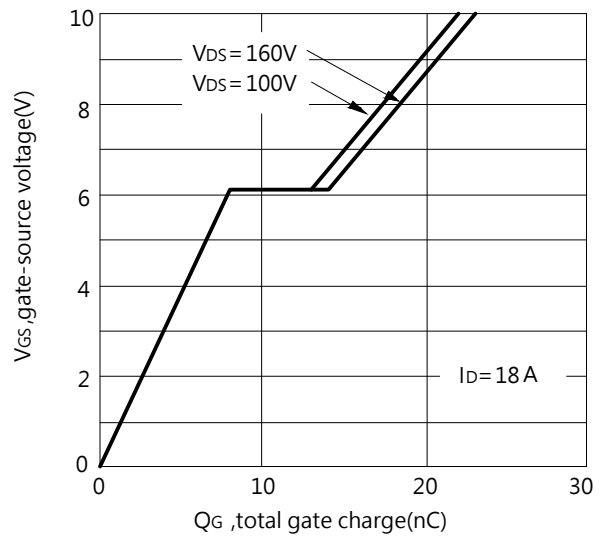
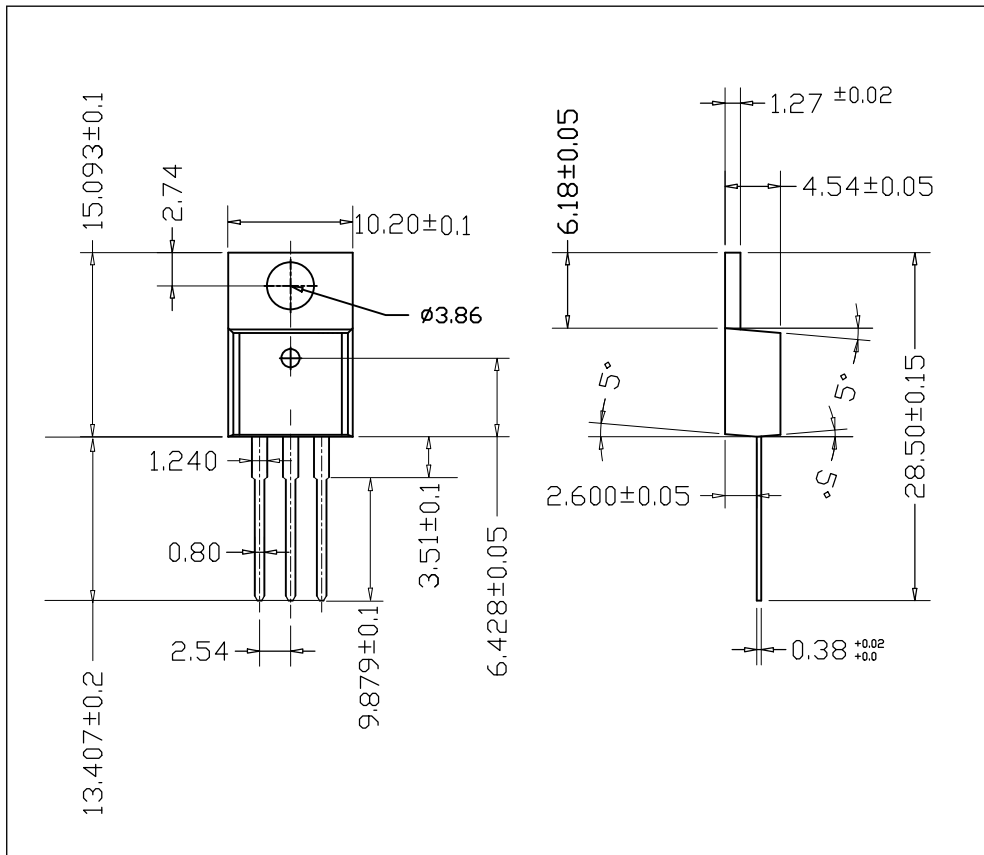


Fig 10 gate charge characteristics

■ TO-220-3L PACKAGE OUTLINE DIMENSIONS



■ TO-220F-3L PACKAGE OUTLINE DIMENSIONS

